

MMSD301T1G, SMMSD301T1G, MMSD701T1G, SMMSD701T1G,

SOD-123 Schottky Barrier Diodes

The MMSD301T1, and MMSD701T1 devices are spin-offs of our popular MMBD301LT1, and MMBD701LT1 SOT-23 devices. They are designed for high-efficiency UHF and VHF detector applications. Readily available to many other fast switching RF and digital applications.

Features

- Extremely Low Minority Carrier Lifetime
- Very Low Capacitance
- Low Reverse Leakage
- AEC Qualified and PPAP Capable
- S Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Reverse Voltage MMSD301T1G, SMMSD301T1G MMSD701T1G, SMMSD701T1G	V_R	30 70	Vdc
Forward Current (DC) Continuous	I_F	200	mA
Forward Power Dissipation $T_A = 25^\circ\text{C}$	P_F	225	mW
Junction Temperature	T_J	-55 to +125	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	-55 to +150	$^\circ\text{C}$

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

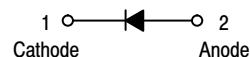


ON Semiconductor®

<http://onsemi.com>



SOD-123
CASE 425
STYLE 1



MARKING DIAGRAM



xx = Specific Device Code
XT = MMSD301T1G
SMMSD301T1G
XH = MMSD701T1G
SMMSD701T1G
M = Date Code
▪ = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping†
MMSD301T1G	SOD-123 (Pb-Free)	3,000 / Tape & Reel
SMMSD301T1G	SOD-123 (Pb-Free)	3,000 / Tape & Reel
MMSD701T1G	SOD-123 (Pb-Free)	3,000 / Tape & Reel
SMMSD701T1G	SOD-123 (Pb-Free)	3,000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MMSD301T1G, SMMSD301T1G, MMSD701T1G, SMMSD701T1G,

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
Reverse Breakdown Voltage (I _R = 10 μA) MMSD301T1G, SMMSD301T1G MMSD701T1G, SMMSD701T1G	V _{(BR)R}	30 70	– –	– –	V
Diode Capacitance (V _R = 0 V, f = 1.0 MHz) MMSD301T1G, SMMSD301T1G MMSD701T1G, SMMSD701T1G	C _T	– –	0.9 0.5	1.5 1.0	pF
Total Capacitance (V _R = 15 V, f = 1.0 MHz) MMSD301T1G, SMMSD301T1G (V _R = 20 V, f = 1.0 MHz) MMSD701T1G, SMMSD701T1G	C _T	– –	0.9 0.5	1.5 1.0	pF
Reverse Leakage (V _R = 25 V) MMSD301T1G, SMMSD301T1G (V _R = 35 V) MMSD701T1G, SMMSD701T1G	I _R	– –	13 9.0	200 200	nA _{dc}
Forward Voltage (I _F = 1.0 mAdc) MMSD301T1G, SMMSD301T1G (I _F = 10 mA) (I _F = 1.0 mAdc) MMSD701T1G, SMMSD701T1G (I _F = 10 mA)	V _F	– – – –	0.38 0.52 0.42 0.7	0.45 0.6 0.5 1.0	V _{dc}

TYPICAL CHARACTERISTICS
MMSD301T1G, SMMSD301T1G

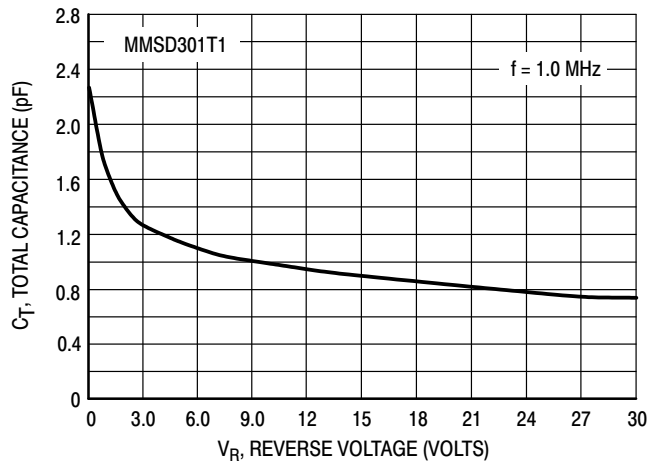


Figure 1. Total Capacitance

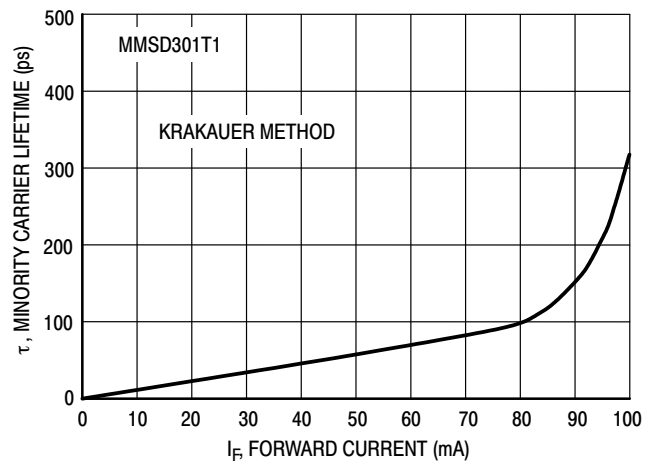


Figure 2. Minority Carrier Lifetime

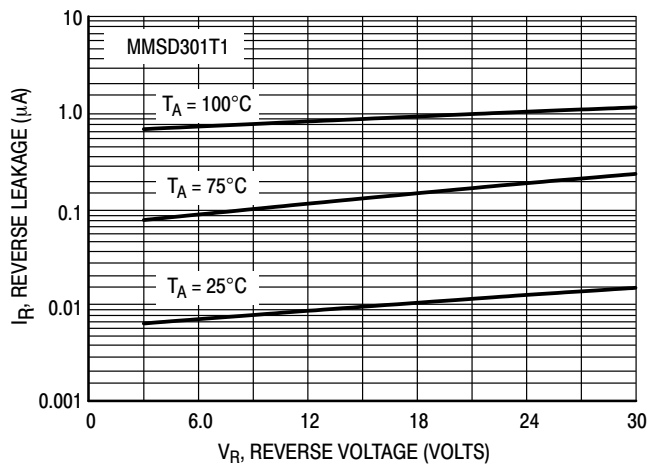


Figure 3. Reverse Leakage

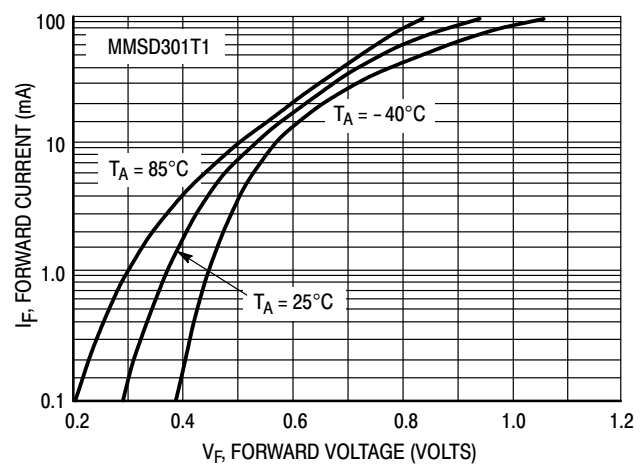


Figure 4. Forward Voltage

TYPICAL CHARACTERISTICS
MMSD701T1G, SMMSD701T1G

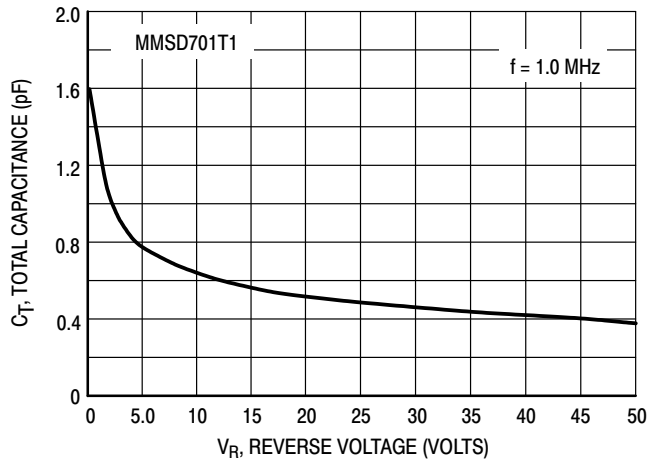


Figure 5. Total Capacitance

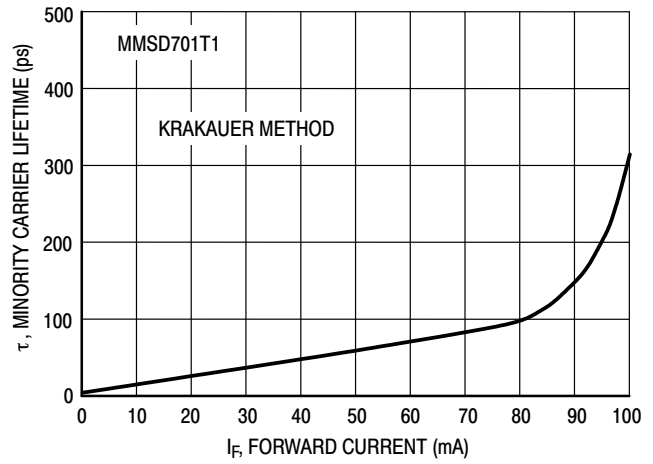


Figure 6. Minority Carrier Lifetime

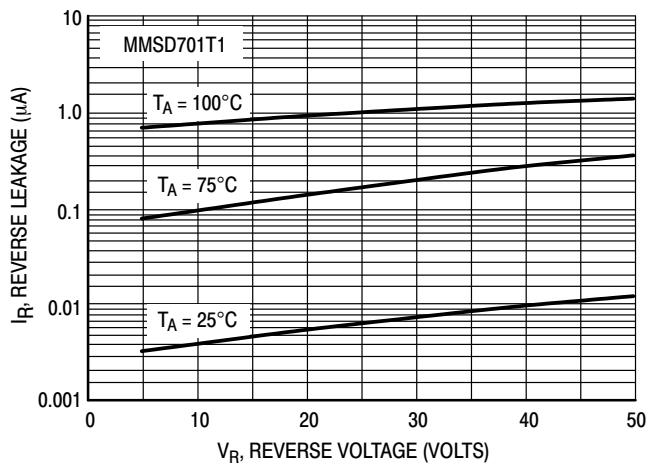


Figure 7. Reverse Leakage

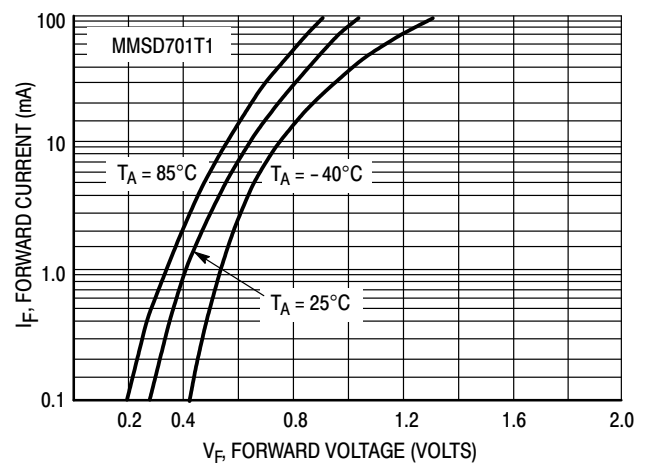
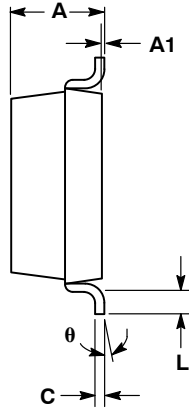
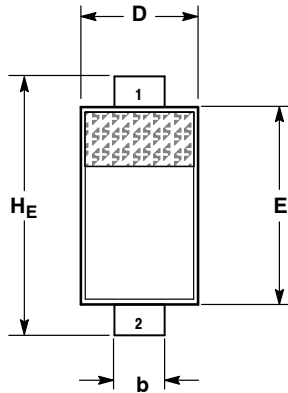


Figure 8. Forward Voltage

MMSD301T1G, SMMSD301T1G, MMSD701T1G, SMMSD701T1G,

PACKAGE DIMENSIONS

SOD-123 CASE 425-04 ISSUE G

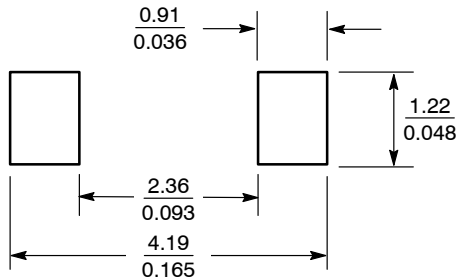


NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.94	1.17	1.35	0.037	0.046	0.053
A1	0.00	0.05	0.10	0.000	0.002	0.004
b	0.51	0.61	0.71	0.020	0.024	0.028
c	---	---	0.15	---	---	0.006
D	1.40	1.60	1.80	0.055	0.063	0.071
E	2.54	2.69	2.84	0.100	0.106	0.112
H_E	3.56	3.68	3.86	0.140	0.145	0.152
L	0.25	---	---	0.010	---	---
theta	0°	---	10°	0°	---	10°

STYLE 1:
PIN 1. CATHODE
2. ANODE

SOLDERING FOOTPRINT*



SCALE 10:1 (mm/inches)

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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MMSD301T1/D



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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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